Octal Buffer/Line Driver with 3-State Outputs

The SN74LS240 and SN74LS244 are Octal Buffers and Line Drivers designed to be employed as memory address drivers, clock drivers and bus-oriented transmitters/receivers which provide improved PC board density.

- Hysteresis at Inputs to Improve Noise Margins
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Input Clamp Diodes Limit High-Speed Termination Effects

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
VCC	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
ІОН	Output Current – High			-3.0	mA
				-15	mA
lOL	Output Current – Low			24	mA



ON Semiconductor

http://onsemi.com

LOW POWER SCHOTTKY

MARKING DIAGRAMS

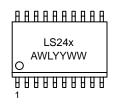


SN74LS24xN
O AWLYYWW

PDIP-20 N SUFFIX CASE 738



SOIC-20 DW SUFFIX CASE 751D





74LS24x AWLYWW

x = 0 or 4

A = Assembly Location

WL = Wafer Lot YY = Year

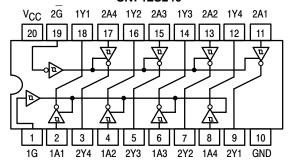
WW = Work Week

ORDERING INFORMATION

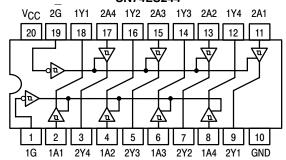
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

LOGIC AND CONNECTION DIAGRAMS DIP (TOP VIEW)

SN74LS240



SN74LS244



TRUTH TABLES

SN74LS240

INP	OUTPUT	
1G, 2G	OUIPUI	
L	L	Н
L	Н	L
Н	Х	(Z)

SN74LS244

INP	OUTPUT		
1G, 2G	1G, 2G D		
L	L	L	
L	Н	Н	
Н	Х	(Z)	

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits					
Symbol	Paramete	•	Min	Тур	Max	Unit	Test (Conditions
VIH	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V _{IL}	Input LOW Voltage				0.8	V	Guaranteed Input LOW Voltage for All Inputs	
V _{T+} -V _{T-}	Hysteresis		0.2	0.4		V	V _{CC} = MIN	
VIK	Input Clamp Diode Volta	ige		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} =	-18 mA
Vou	Output HIGH Voltage		2.4	3.4		V	V _{CC} = MIN, I _{OH}	= -3.0 mA
VOH	Output HIGH Voltage		2.0			V	V _{CC} = MIN, I _{OH} = MAX	
.,	V _{OL} Output LOW Voltage			0.25	0.4	V	I _{OL} = 12 mA	$V_{CC} = V_{CC} MIN,$
VOL				0.35	0.5	V	I _{OL} = 24 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
lozh	Output Off Current HIGH	1			20	μΑ	V _{CC} = MAX, V _{OUT} = 2.7 V	
lozL	Output Off Current LOW	1			-20	μΑ	V _{CC} = MAX, V _{OL}	JT = 0.4 V
l	Input HIGH Current				20	μΑ	V _{CC} = MAX, V _{IN}	= 2.7 V
lіН	input riiGi i Cuirent				0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V	
I _I L	Input LOW Current				-0.2	mA	V _{CC} = MAX, V _{IN}	= 0.4 V
los	Output Short Circuit Cui	rent (Note 1)	-40		-225	mA	$V_{CC} = MAX$	
	Power Supply Current Total, Output HIGH				27			
ICC	Total, Output LOW	LS240			44			
		LS244			46	mA	$V_{CC} = MAX$	
		LS240			50			
	LS244				54			

^{1.} Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS (TA = 25° C, V_{CC} = 5.0 V)

		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
^t PLH ^t PHL	Propagation Delay, Data to Output LS240		9.0 12	14 18	ns	
^t PLH ^t PHL	Propagation Delay, Data to Output LS244		12 12	18 18	ns	C_L = 45 pF, R_L = 667 Ω
^t PZH	Output Enable Time to HIGH Level		15	23	ns	
^t PZL	Output Enable Time to LOW Level		20	30	ns	
^t PLZ	Output Disable Time from LOW Level		15	25	ns	C _L = 5.0 pF,
^t PHZ	Output Disable Time from HIGH Level		10	18	ns	$R_L = 667 \Omega$

AC WAVEFORMS

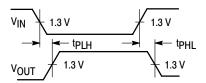


Figure 1.

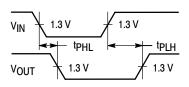


Figure 2.

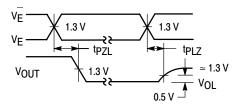


Figure 3.

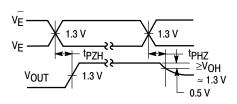
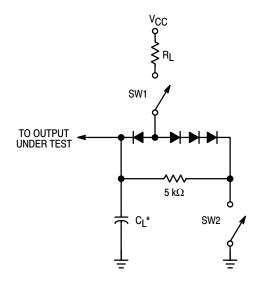


Figure 4.



SWITCH POSITIONS

SYMBOL	SW1	SW2
^t PZH	Open	Closed
^t PZL	Closed	Open
^t PLZ	Closed	Closed
^t PHZ	Closed	Closed

Figure 5.

DEVICE ORDERING INFORMATION

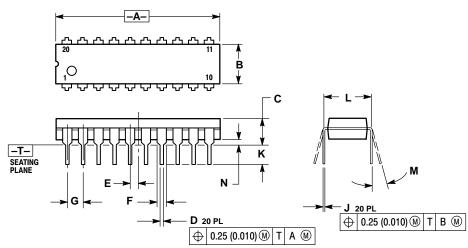
Device Order Number	Package Type	Tape and Reel Size
SN74LS240N	PDIP-20	1440 Units/Box
SN74LS240DW	SOIC-WIDE	38 Units/Rail
SN74LS240DWR2	SOIC-WIDE	2500/Tape and Reel
SN74LS240M	SOEIAJ-20	See Note 2
SN74LS240MEL	SOEIAJ-20	See Note 2
SN74LS244N	PDIP-20	1440 Units/Box
SN74LS244DW	SOIC-WIDE	38 Units/Rail
SN74LS244DWR2	SOIC-WIDE	2500/Tape and Reel
SN74LS244M	SOEIAJ-20	See Note 2
SN74LS244MEL	SOEIAJ-20	See Note 2

^{2.} For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

PACKAGE DIMENSIONS

N SUFFIX

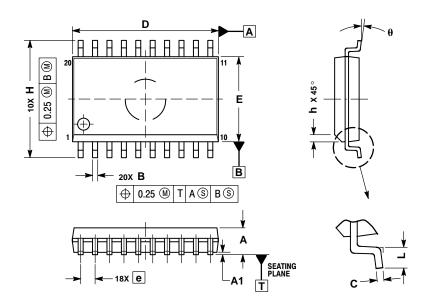
PLASTIC PACKAGE CASE 738-03 ISSUE E



- IOLES:
 1 DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN
 FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD
- FLASH.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MIN MAX		MAX	
Α	1.010	1.070	25.66	27.17	
В	0.240	0.260	6.10	6.60	
С	0.150	0.180	3.81	4.57	
D	0.015	0.022	0.39	0.55	
Е	0.050	BSC	1.27 BSC		
F	0.050	0.070	1.27	1.77	
G	0.100	BSC	2.54 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.140	2.80	3.55	
Ĺ	0.300 BSC		7.62	BSC	
M	0 °	15°	0°	15°	
N	0.020	0.040	0.51	1.01	

D SUFFIX PLASTIC SOIC PACKAGE CASE 751D-05 ISSUE F



- NOTES:

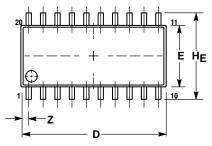
 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES
 PER ASME Y14.5M, 1994.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- MAXIMUM MOLD FRO HOSION 0.15 PER SIDE.
 DIMENSION B DOES NOT INCLUDE DAMBAR
 PROTRUSION. ALLOWABLE PROTRUSION SHALL
 BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT
 MAXIMUM MATERIAL CONDITION.

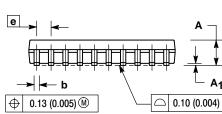
	MILLIMETERS				
DIM	MIN	MAX			
Α	2.35	2.65			
A1	0.10	0.25			
В	0.35	0.49			
c	0.23	0.32			
D	12.65	12.95			
Е	7.40	7.60			
е	1.27	BSC			
Н	10.05	10.55			
h	0.25	0.75			
۲	0.50	0.90			
	0.0	7 (

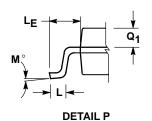
PACKAGE DIMENSIONS

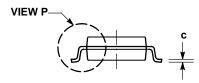
M SUFFIX

SOEIAJ PACKAGE CASE 967-01 **ISSUE O**









NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD
 FLASH OR PROTRUSIONS AND ARE MEASURED
 AT THE PARTING LINE. MOLD FLASH OR
 PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006)
- PHOTHUSIONS SHALL NOT EXCEED 0.15 (0.006)
 PER SIDE.
 TERMINAL NUMBERS ARE SHOWN FOR
 REFERENCE ONLY.
 THE LEAD WIDTH DIMENSION (b) DOES NOT
 INCLUDE DAMBAR PROTRUSION. ALLOWABLE
 DAMBAR PROTRUSION SHALL BE 0.08 (0.003)
 TOTAL IN EXCESS OF THE LEAD WIDTH
 DIMENSION AT MAXIMUM MATERIAL CONDITION.
 ANDRIB CANNOT BELLOWED. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
Α ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
C	0.18	0.27	0.007	0.011
D	12.35	12.80	0.486	0.504
Е	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050 BSC	
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0 °	10 °	0 °	10°
Q ₁	0.70	0.90	0.028	0.035
Z		0.81		0.032

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